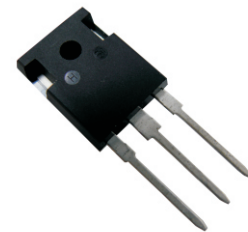


FRED Ultrafast Soft Recovery Diode 2 x 30A / 600V

FEATURES

- Ultrafast recovery
- Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- Specified at operating conditions
- Designed and qualified for industrial level
- Planar FRED Chip



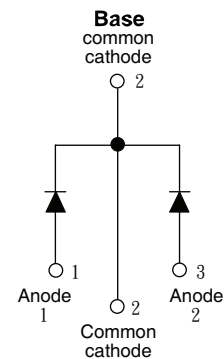
TO-247 AB

BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

HFA60PA60C is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600V and 30A per leg continuous current, the HFA60PA60C is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the FRED product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The FRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These FRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The FRED HFA60PA60C is ideally suited for applications in power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.



PRODUCT SUMMARY

V_R	600 V
V_F at 30A at 25 °C	1.7 V
$I_{F(AV)}$	2 x 30 A
t_{rr} (typical)	25 ns
T_J (maximum)	175 °C
Q_{rr} (typical)	130 nC
I_{RRM} (typical)	3.0 A

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Cathode to anode voltage	V_R		600	V
Maximum continuous forward current	I_F	$T_C = 115\text{ °C}$	30	A
per leg			60	
per device			300	
Single pulse forward current	I_{FSM}		300	
Operating junction and storage temperature range	T_J, T_{Stg}		- 55 to + 175	°C

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA	600	-	-	V
Maximum forward voltage	V _{FM}	I _F = 30 A	-	1.4	1.7	
		I _F = 60 A	-	1.7	2.0	
		I _F = 30 A, T _J = 125 °C	-	1.1	1.4	μA
Maximum reverse leakage current	I _{RM}	V _R = V _R rated	-	1.0	10	
		T _J = 150V _R = V _R rated	-	-	500	
Junction capacitance	C _T	V _R = 200V	-	36	-	pF

DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t _{rr}	I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A (RG#1 CKT)	-	32	38	ns
		I _F = 1.0 A, dI _F /dt = 100 A/μs, V _R = 30 V, T _J = 25°C	-	25	-	
	t _{rr1}	T _J = 25 °C	-	30	50	
	t _{rr2}	T _J = 125 °C	-	175	-	
Peak recovery current	I _{RRM1}	T _J = 25 °C	-	3	-	A
	I _{RRM2}	T _J = 125 °C	-	6	-	
Reverse recovery charge	Q _{rr1}	T _J = 25 °C	-	130	-	nC
	Q _{rr2}	T _J = 125 °C	-	485	-	

THERMAL - MECHANICAL SPECIFICATIONS PER LEG						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Junction to case, single leg conduction	R _{thJC}		-	-	0.8	K/W
Junction to case, both legs conducting			-	-	0.4	
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	40	
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.4	-	
Weight			-	6.0	-	g
			-	0.21	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf . cm (lbf . in)
Marking device		Case style TO-247AB (JEDEC)	HFA60PA60C			

Fig.1 Maximum effective transient thermal impedance, junction-to-case vs. pulse duration

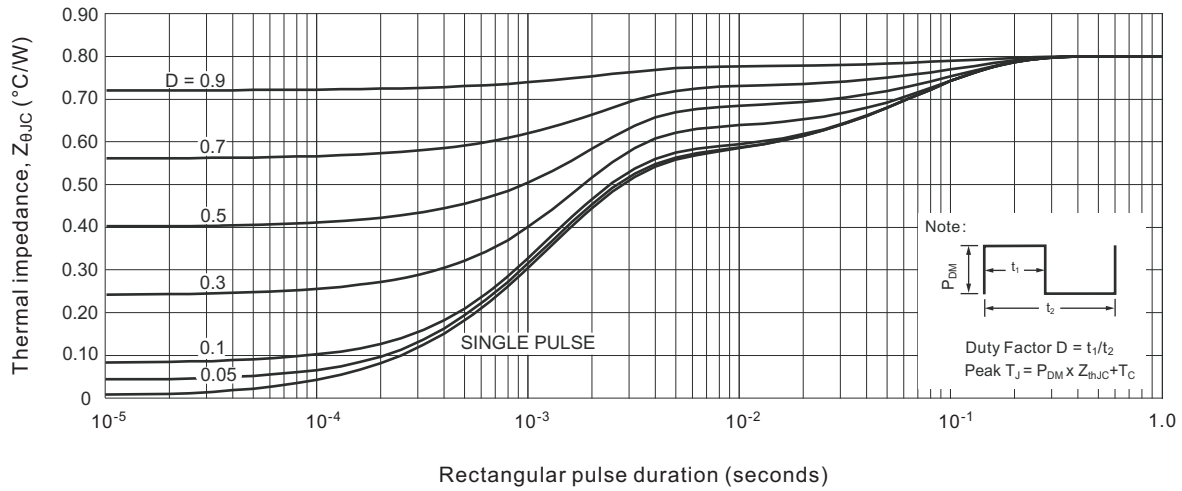


Fig.2 Forward current vs. forward voltage

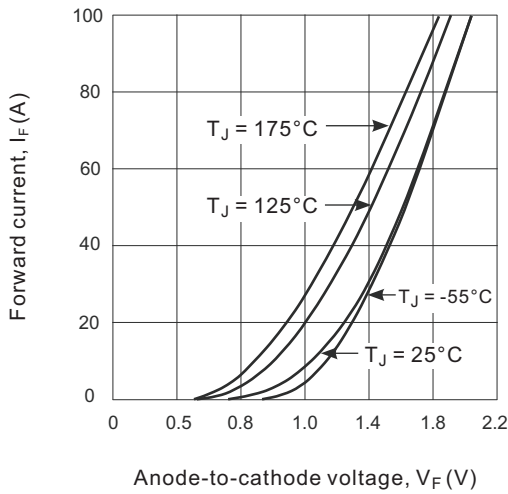


Fig.3 Reverse recovery time vs. current rate of change

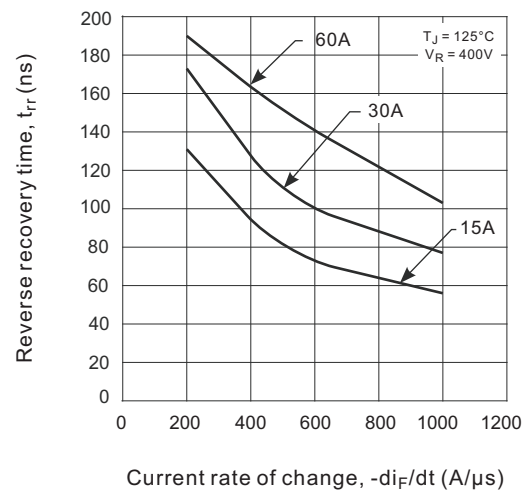


Fig.4 Reverse recovery charge vs. current rate of change

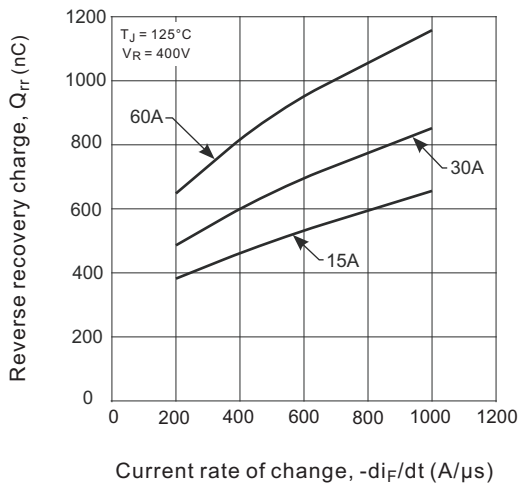


Fig 5. Reverse recovery current vs. current rate of change

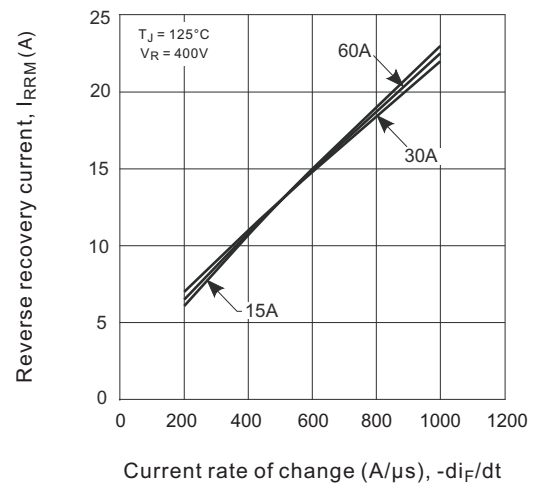


Fig.6. Dynamic parameters vs. junction temperature

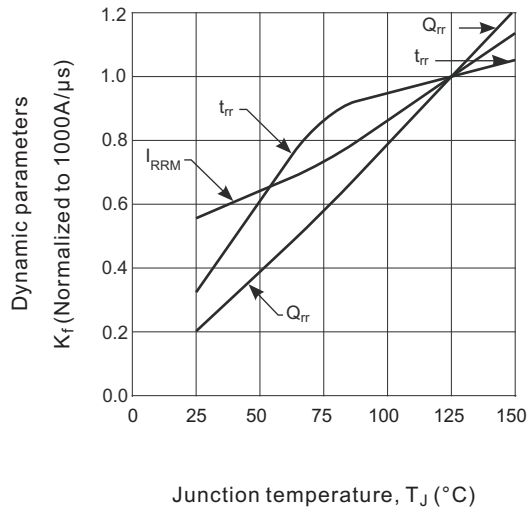


Fig.7 Maximum average forward current vs. case temperature

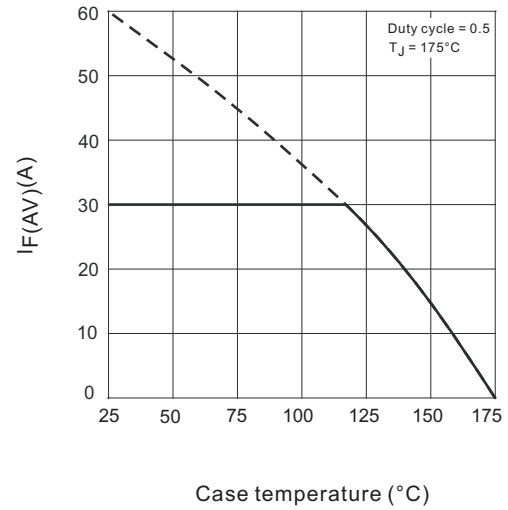
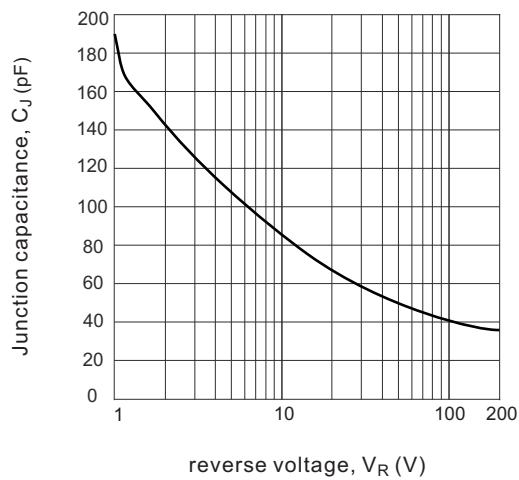


Fig.8 Junction capacitance vs. reverse voltage



ORDERING INFORMATION TABLE

Device code	HFA	60	PA	60	C
	①	②	③	④	⑤

- ① - FRED family
- ② - Current rating (60 = 60 A, 30A x 2)
- ③ - Package outline (PA = TO-247, 3 pins)
- ④ - Voltage rating (60 = 600 V)
- ⑤ - Configuration (C = Center tap common cathode)

